



AO4832

Common-Drain Dual N-Channel Enhancement Mode Field Effect Transistor

General Description

The AO4832 uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications. Standard Product AO4832 is Pb-free (meets ROHS & Sony 259 specifications). AO4832L is a Green Product ordering option. AO4832 and AO4832L are electrically identical.

Features

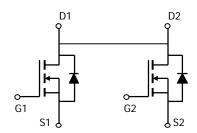
$$V_{DS}(V) = 30V$$

 $I_{D} = 8 A (V_{GS} = 10V)$

$$R_{DS(ON)}$$
 < 15m Ω (V_{GS} = 10V)

$$R_{DS(ON)} < 17 m\Omega (V_{GS} = 4.5)$$

$$R_{DS(ON)}$$
 < 23m Ω (V_{GS} = 2.5V)



Absolute Maximum Ratings T _A =25°C unless otherwise noted								
Parameter		Symbol	Maximum	Units				
Drain-Source Voltage		V_{DS}	30	V				
Gate-Source Voltage		V_{GS}	±12	V				
Continuous Drain	T _A =25°C		8					
Current ^A	T _A =70°C	I_D	6	A				
Pulsed Drain Current ^B		I _{DM}	30					
	T _A =25°C	В	1.5	W				
Power Dissipation A	T _A =70°C	$-P_{D}$	1					
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	°C				

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{ heta JA}$	64	83	°C/W			
Maximum Junction-to-Ambient ^A	Steady-State	κ_{θ} JA	89	120	°C/W			
Maximum Junction-to-Lead ^C	Steady-State	$R_{ heta JL}$	53	70	°C/W			

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC I	PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$		30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =24V, V _{GS} =0V				1	μА
			T _J =55°C			5	μΑ
I_{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±12V				±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS} I_{D}=250\mu A$		0.6	1	1.4	V
$I_{D(ON)}$	On state drain current	V_{GS} =4.5V, V_{DS} =5V		30			Α
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =8A			12.2	15	mΩ
		1	Γ _J =125°C		17	21	11122
		V_{GS} =4.5V, I_D =5A			13	17	mΩ
		V_{GS} =2.5V, I_D =4A		17.6	23	mΩ	
g _{FS}	Forward Transconductance	V_{DS} =5V, I_{D} =8A			23		S
V_{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V			0.73	1	V
Is	Maximum Body-Diode Continuous Current					2.5	Α
DYNAMI	PARAMETERS		•		•	•	
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =15V, f=1MHz			1130		pF
Coss	Output Capacitance				170		pF
C _{rss}	Reverse Transfer Capacitance				125		pF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			1.5		Ω
SWITCHI	NG PARAMETERS	•	•		•		
Q_g	Total Gate Charge	V _{GS} =4.5V, V _{DS} =15V, I _D =8A			14		nC
Q_{gs}	Gate Source Charge				1.65		nC
Q_{gd}	Gate Drain Charge				5.5		nC
t _{D(on)}	Turn-On DelayTime				5.7		ns
t _r	Turn-On Rise Time	V_{GS} =5V, V_{DS} =15V, R_L =1.8 Ω , R_{GEN} =3 Ω			4.8		ns
t _{D(off)}	Turn-Off DelayTime				36		ns
t _f	Turn-Off Fall Time				7		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =8A, dI/dt=100A/μs			23		ns
Q _{rr}	Body Diode Reverse Recovery Charge	l _F =8A, dI/dt=100A/μs			16		nC

A: The value of $R_{\theta JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t≤ 10s thermal resistance rating

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B: Repetitive rating, pulse width limited by junction temperature.

C. The $R_{\theta JA}$ is the sum of the thermal impedence from junction to lead $R_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6,12,14 are obtained using $80\,\mu s$ pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

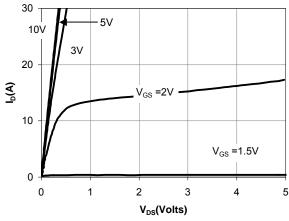


Figure 1: On-Regions CharacteristiCS

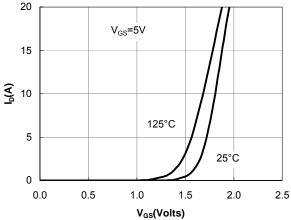


Figure 2: Transfer Characteristics

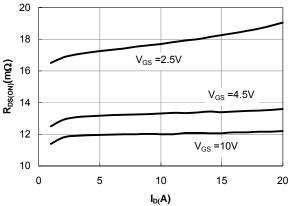


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

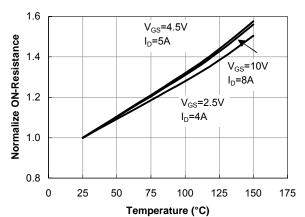


Figure 4: On-Resistance vs. Junction Temperature

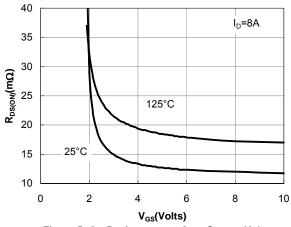


Figure 5: On-Resistance vs. Gate-Source Voltage

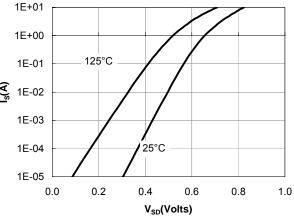
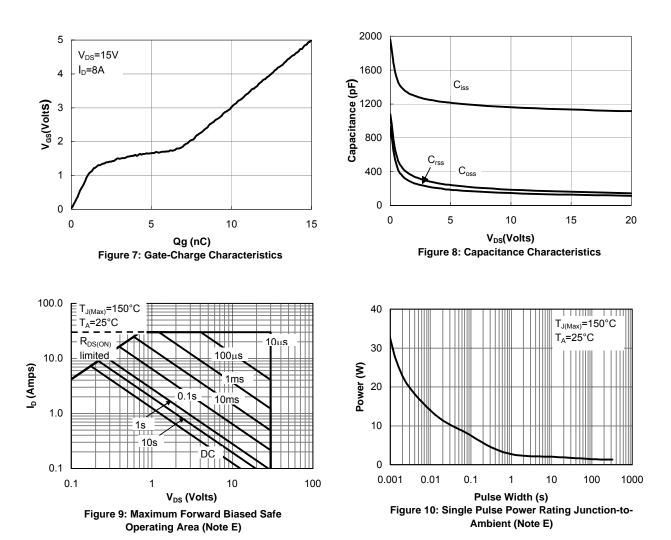


Figure 6: Body-Diode Characteristics

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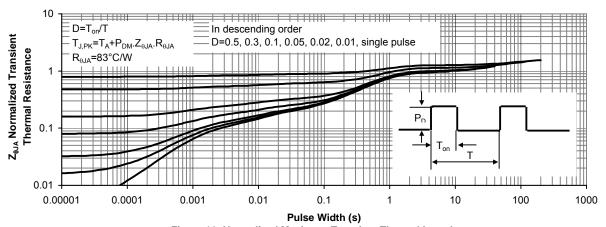


Figure 11: Normalized Maximum Transient Thermal Impedance